

**Surface Mount Schottky Barrier Rectifier****FEATURES**

- Ideal for automated placement
- Low forward voltage drop
- Low leakage current
- Meets environmental standard MIL-S-19500D
- Moisture sensitivity:level 1, per J-STD-020
- Solder dip 275 °C, 10 s
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



DO-214AC (SMA)

**TYPICAL APPLICATIONS**

For use in general purpose rectification of lighting, power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

PRIMARY CHARACTERISTICS	
I <sub>F(AV)</sub>	2 A
V <sub>RRM</sub>	20 V to 100 V
I <sub>FSM</sub>	45A
V <sub>F</sub>	0.42V, 0.47V, 0.72V
T <sub>J</sub> max.	125 °C , 150 °C

**MECHANICAL DATA**

**Case:** DO-214AC, molded epoxy body, Epoxy meets UL 94V-0 flammability rating

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD22B-106

**Polarity:** Laser Band Denotes Cathode Band

**MAXIMUM RATINGS (T<sub>A</sub> = 25 °C unless otherwise noted)**

PARAMETER	SYMBOL	SL22A	SL23A	SL24A	SL25A	SL26A	SL27A	SL28A	SL29A	SL210A	UNIT
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	20	30	40	50	60	70	80	90	100	V
Maximum RMS voltage	V <sub>RMS</sub>	14	21	28	35	42	49	56	63	70	V
Maximum DC blocking voltage	V <sub>DC</sub>	20	30	40	50	60	70	80	90	100	V
Maximum average forward rectified current at TL (See Fig.1)	I <sub>F(AV)</sub>						2				A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>						45				A
Operating junction temperature range	T <sub>J</sub>	- 55 to + 125			- 55 to + 150			°C			
Storage temperature range	T <sub>stg</sub>				- 55 to + 150			°C			

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	SL22A	SL23A	SL24A	SL25A	SL26A	SL27A	SL28A	SL29A	SL210A	UNIT
Maximum instantaneous forward voltage	IF=2 A	V <sub>F</sub>		0.42		0.47		0.72				V
Maximum DC reverse current at rated DC blocking voltage	TA=25°C	I <sub>R</sub>		0.2				0.15				mA
	TA=100°C			10				TBD				
Typical junction capacitance	4.0 V, 1 MHz	C <sub>J</sub>						175				pF

THERMAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

PARAMETER	SYMBOL	SL22A	SL23A	SL24A	SL25A	SL26A	SL27A	SL28A	SL29A	SL210A	UNIT
Maximum thermal resistance	R <sub>θJA</sub> (1)							TBD			°C/W
	R <sub>θJT</sub> (2)							TBD			

Notes: (1) Thermal resistance from junction to ambient,  $0.197 \times 0.197''$  (5.0×5.0mm) copper pads to each terminal

(2) Thermal resistance from junction to terminal,  $0.197 \times 0.197''$  (5.0×5.0mm) copper pads to each terminal

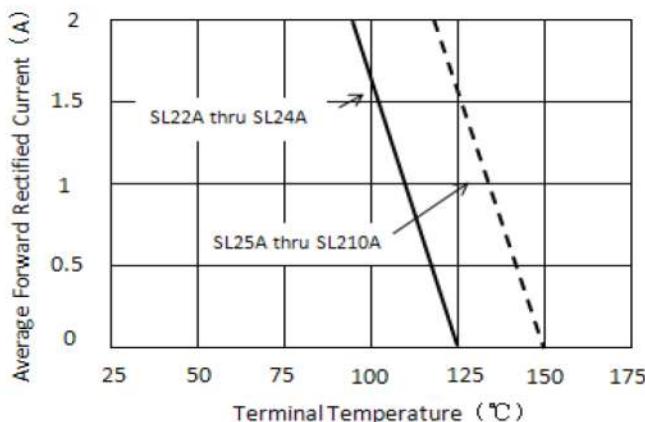
RATINGS AND CHARACTERISTICS CURVES  
( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Figure 1. Forward Current Derating Curve

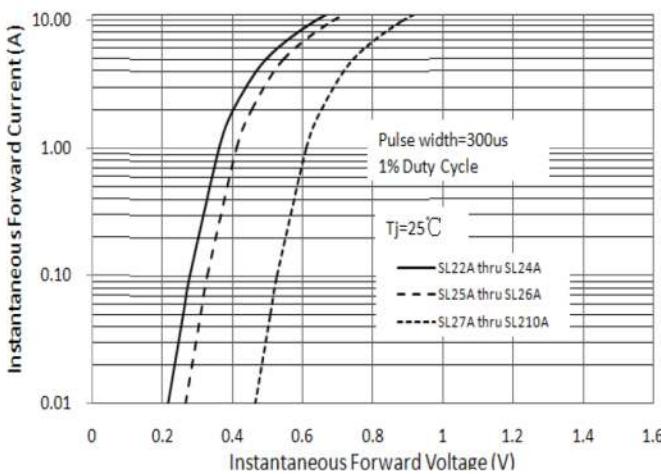


Figure 3. Typical Instantaneous Forward Characteristics

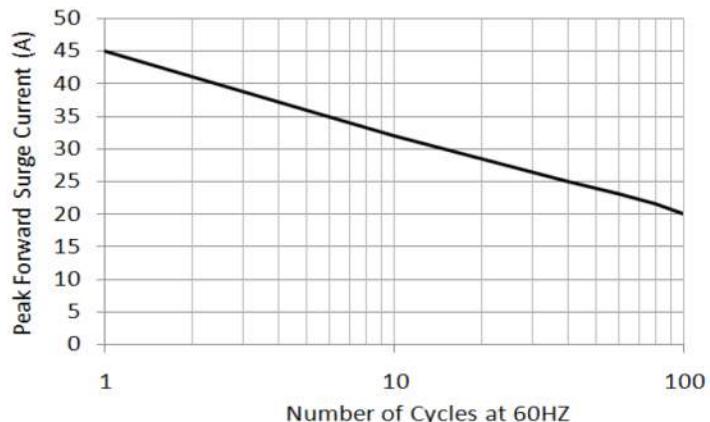


Figure 2. Maximum Non-repetitive Peak Forward Surge Current

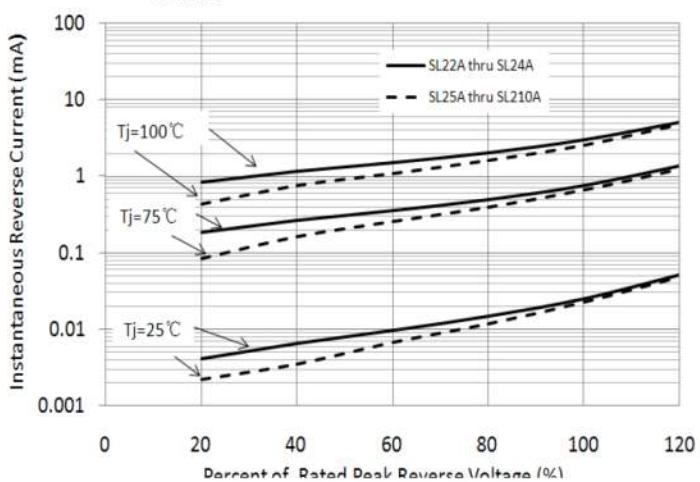


Figure 4. Typical Reverse Characteristics

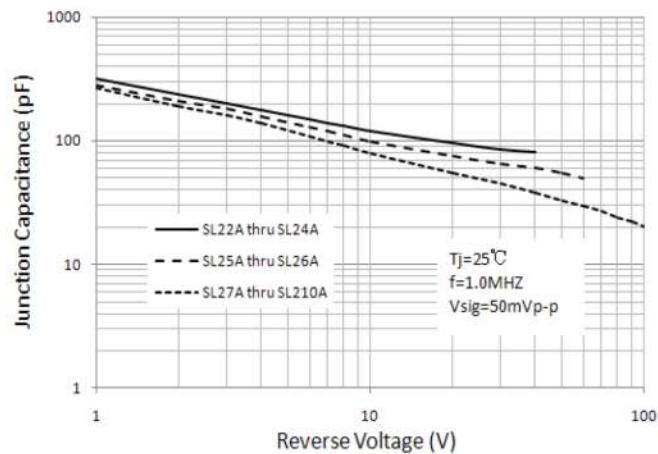


Figure 5. Typical Junction Capacitance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

